Characteristics STTH802

1 Characteristics

Table 2: Absolute ratings (limiting values at 25 °C, unless otherwise specified)

Symbol	Parameter			Value	Unit
V _{RRM}	Repetitive peak reverse v	oltage		200	V
I _{F(RMS)}	Forward rms current			16	Α
I _{F(AV)}	Average forward current	TO-220AC, DPAK, D ² PAK	T _C = 145 °C	8	А
, ,	δ = 0.5, square wave	TO-220FPAC	T _C = 125 °C		
I _{FSM}	Surge non repetitive forward current	tp = 10 ms sinusoidal		100	Α
T _{stg}	Storage temperature rang	e	-65 to +175	°C	
Tj	Maximum operating juncti	Maximum operating junction temperature			°C

Table 3: Thermal parameter

Symbol	Parameter Ma			Unit
D	lunation to acco	TO-220AC, DPAK, D ² PAK	3.2	°C/W
R _{th(j-c)} Junction to case		TO-220FPAC	5.5	C/VV

Table 4: Static electrical characteristics

	Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
	I _R ⁽¹⁾	Doverse leeke se current	T _j = 25 °C	V _R = V _{RRM}	-		6	μA
	IR ^(*)	Reverse leakage current	T _j = 125 °C		-	6	60	
ſ	V _F ⁽²⁾	Converd voltage drap	T _j = 25 °C	Ι_ ΟΛ	-	0.95	1.05	V
		Forward voltage drop	T _j = 150 °C	I _F = 8 A	-	0.80	0.90	V

Notes:

 $^{(1)}$ Pulse test: t_p = 5 ms, δ < 2%

 $^{(2)}$ Pulse test: t_p = 380 µs, δ < 2%

To evaluate the conduction losses, use the following equation:

 $P = 0.73 \text{ x } I_{F(AV)} + 0.021 \text{ x } I_{F^2(RMS)}$

STTH802 Characteristics

Table 5: Dynamic electrical characteristics

Symbol	Parameter	Tes	Min.	Тур.	Max.	Unit	
	Doverse recovery time	T _j = 25 °C	$I_F = 1 A,$ $dI_F/dt = -50 A/\mu s,$ $V_R = 30 V$	-	25	30	ns
trr	Reverse recovery time	T _j = 25 °C	I _F = 1 A, dI _F /dt = -100 A/μs, V _R = 30 V	-	17	22	ns
I _{RM}	Reverse recovery current	T _j = 125 °C	$I_F = 8 \text{ A},$ $dI_F/dt = -200 \text{ A/}\mu\text{s},$ $V_R = 160 \text{ V}$	-	5.5	7.0	А
t _{fr}	Forward recovery time	T _j = 25 °C	I _F = 8 A, dI _F /dt = 50 A/μs, V _{FR} = 1.1 x V _{Fmax}	-	150		ns
V _{FP}	Forward recovery voltage	T _j = 25 °C	I _F = 8 A, dI _F /dt = 50 A/µs	-	1.5		V

Characteristics STTH802

1.1 Characteristics (curves)

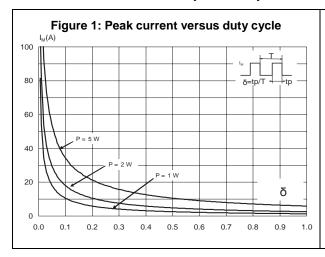


Figure 2: Forward voltage drop versus forward current (typical values) $I_F(A)$ 200 180 160 140 120 100 T;=150°C T,=25°C 40 20 0.0 0.5 1.0 1.5

Figure 3: Forward voltage drop versus forward current (maximum values) 200 180 160 140 120 100 60 40 20 $V_{F}\left(V\right)$ 0 0.5 1.0 1.5 2.0 0.0 2.5

Figure 4: Relative variation of thermal impedance, junction to case, versus pulse duration

Z_{0.(j-c)}/R_{0-(j-c)}

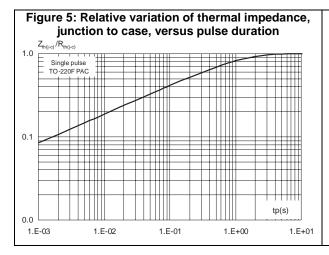
1.0

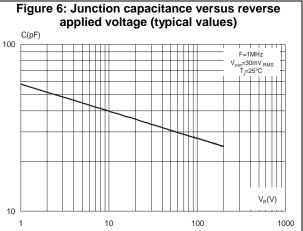
Single pulse
TO-220 AC
DPAK
D²PAK
D²PAK
1.E-03

1.E-02

1.E-01

1.E+00

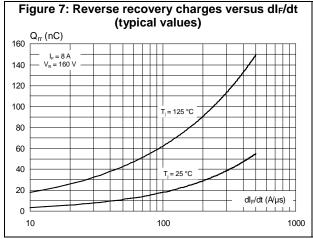




4/17 DocID12362 Rev 3

577

STTH802 Characteristics



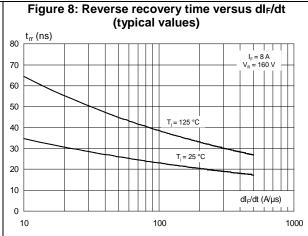
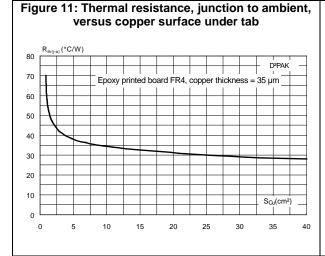
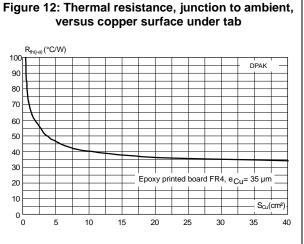


Figure 10: Relative variation of dynamic parameters versus junction temperature

1.4

1.2 $I_F = 8 \text{ A}$ $V_R = 160 \text{ V}$ $V_R = 160 \text{ V}$ $V_R = 160 \text{ V}$ $V_R = 100 \text$





Package information STTH802

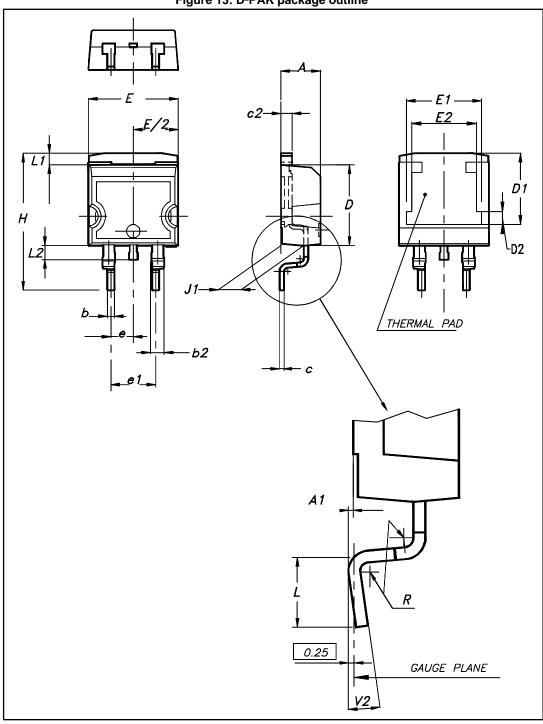
2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.

- Cooling method: by conduction (C)
- Epoxy meets UL 94,V0
- Recommended torque value: 0.55 N·m (for TO-220AC and TO-220FPAC)
- Maximum torque value: 0.7 N·m (for TO-220AC and TO-220FPAC)

2.1 D²PAK package information

Figure 13: D²PAK package outline

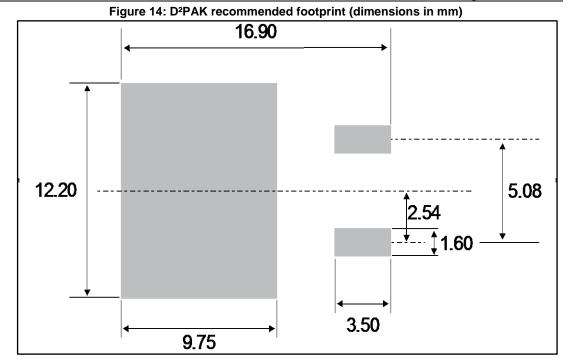


8

This package drawing may slightly differ from the physical package. However, all the specified dimensions are guaranteed.

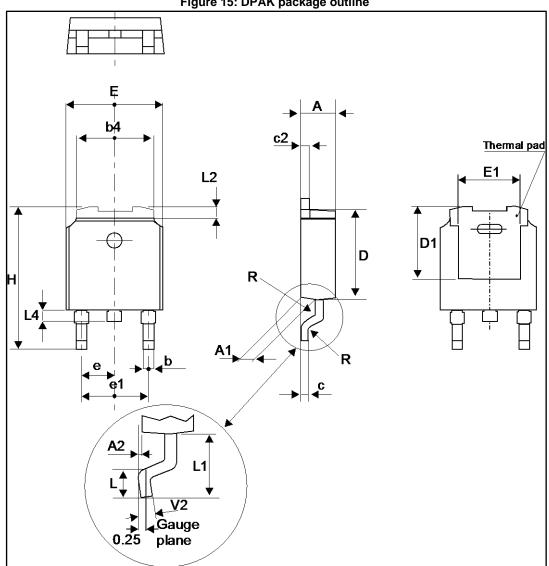
Table 6: D²PAK package mechanical data

		PAK package med Dime	nsions	
Ref.	Millimeters		Inch	nes
	Min.	Max.	Min.	Max.
А	4.36	4.60	0.172	0.181
A1	0.00	0.25	0.000	0.010
b	0.70	0.93	0.028	0.037
b2	1.14	1.70	0.045	0.067
С	0.38	0.69	0.015	0.027
c2	1.19	1.36	0.047	0.053
D	8.60	9.35	0.339	0.368
D1	6.90	8.00	0.272	0.311
D2	1.10	1.50	0.043	0.060
Е	10.00	10.55	0.394	0.415
E1	8.10	8.90	0.319	0.346
E2	6.85	7.25	0.266	0.282
е	2.54	typ.	0.1	00
e1	4.88	5.28	0.190	0.205
Н	15.00	15.85	0.591	0.624
J1	2.49	2.90	0.097	0.112
L	1.90	2.79	0.075	0.110
L1	1.27	1.65	0.049	0.065
L2	1.30	1.78	0.050	0.070
R	0.4 t	yp.	0.0	15
V2	0°	8°	0°	8°



DPAK package information 2.2

Figure 15: DPAK package outline

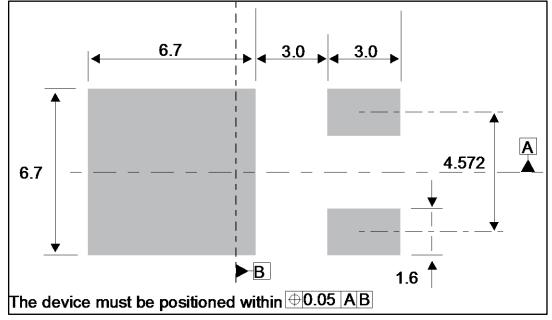


This package drawing may slightly differ from the physical package. However, all the specified dimensions are guaranteed.

Table 7: DPAK package mechanical data

		Din	Dimensions			
Ref.	Mill	imeters	Inc	hes		
	Min.	Max.	Min.	Max.		
А	2.18	2.40	0.085	0.094		
A1	0.90	1.10	0.035	0.043		
A2	0.03	0.23	0.001	0.009		
b	0.64	0.90	0.025	0.035		
b4	4.95	5.46	0.194	0.215		
С	0.46	0.61	0.018	0.024		
c2	0.46	0.60	0.018	0.023		
D	5.97	6.22	0.235	0.244		
D1	4.95	5.60	0.194	0.220		
E	6.35	6.73	0.250	0.265		
E1	4.32	5.50	0.170	0.216		
е	2.2	2.286 typ.		0 typ.		
e1	4.40	4.70	0.173	0.185		
Н	9.35	10.40	0.368	0.409		
L	1.0	1.78	0.039	0.070		
L2		1.27		0.050		
L4	0.60	1.02	0.023	0.040		
V2	-8°	+8°	-8°	+8°		

Figure 16: DPAK recommended footprint (dimensions in mm)





Package information STTH802

2.3 TO-220AC package information

Figure 17: TO-220AC package outline

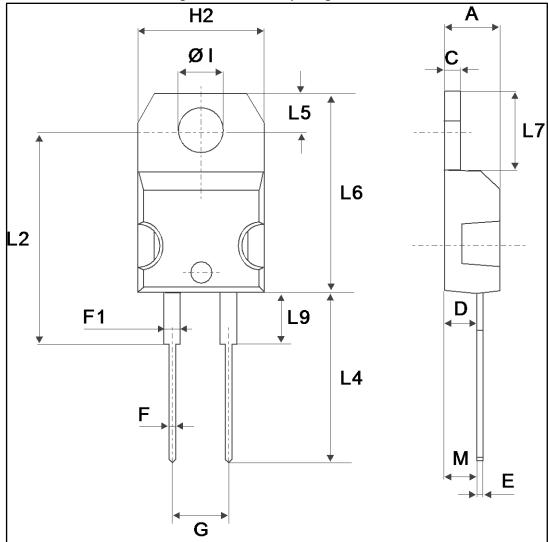


Table 8: TO-220AC package mechanical data

		Dimensions				
Ref.	Millim	neters	Inches			
	Min.	Max.	Min.	Max.		
А	4.40	4.60	0.173	0.181		
С	1.23	1.32	0.048	0.051		
D	2.40	2.72	0.094	0.107		
Е	0.49	0.70	0.019	0.027		
F	0.61	0.88	0.024	0.034		
F1	1.14	1.70	0.044	0.066		
G	4.95	5.15	0.194	0.202		
H2	10.00	10.40	0.393	0.409		
L2	16.40	O typ.	0.645 typ.			
L4	13.00	14.00	0.511	0.551		
L5	2.65	2.95	0.104	0.116		
L6	15.25	15.75	0.600	0.620		
L7	6.20	6.60	0.244	0.259		
L9	3.50	3.93	0.137	0.154		
M	2.6	typ.	0.102	2 typ.		
ØI	3.75	3.85	0.147	0.151		



Package information STTH802

2.4 TO-220FPAC package information

Figure 18: TO-220FPAC package outline

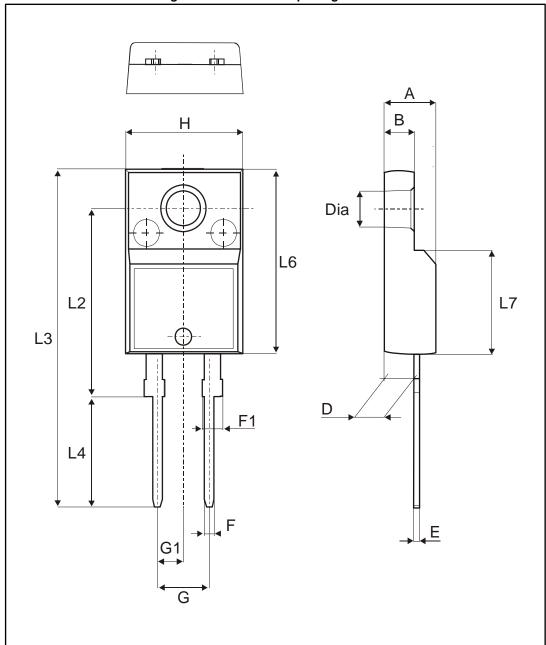


Table 9: TO-220FPAC package mechanical data

	Dimensions					
Ref.	Millim	neters	Inches			
	Min.	Max.	Min.	Max.		
А	4.40	4.60	0.173	0.181		
В	2.50	2.70	0.098	0.106		
D	2.50	2.75	0.098	0.108		
E	0.45	0.70	0.018	0.027		
F	0.75	1.00	0.030	0.039		
F1	1.15	1.70	0.045	0.067		
G	4.95	5.20	0.195	0.205		
G1	2.40	2.70	0.094	0.106		
Н	10.00	10.40	0.393	0.409		
L2	16.00	O typ.	0.630) typ.		
L3	28.60	30.60	0.126	1.205		
L4	9.80	10.60	0.386	0.417		
L6	15.90	16.40	0.626	0.646		
L7	9.00	9.30	0.354	0.366		
Dia.	3.00	3.20	0.118	0.126		

Ordering information STTH802

3 Ordering information

Table 10: Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
STTH802D	STTH802	TO-220AC	1.86g	50	Tube
STTH802FP	STTH802	TO-220FPAC	1.9g	50	Tube
STTH802B-TR	STTH 802	DPAK	0.32g	2500	Tape and reel
STTH802G	STTH802	D ² PAK	1.38g	50	Tube
STTH802G-TR	STTH802	D ² PAK	1.38g	1000	Tape and reel

4 Revision history

Table 11: Document revision history

Date	Revision	Changes
03-may-2006	1	First issue.
22-Sep-2006	2	Added D ² PAK package.
07-Aug-2017	3	Updated features and image in cover page. Updated Section 1.1: "Characteristics (curves)". Updated Section 2: "Package information". Minor text changes.

IMPORTANT NOTICE - PLEASE READ CAREFULLY

STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, enhancements, modifications, and improvements to ST products and/or to this document at any time without notice. Purchasers should obtain the latest relevant information on ST products before placing orders. ST products are sold pursuant to ST's terms and conditions of sale in place at the time of order acknowledgement.

Purchasers are solely responsible for the choice, selection, and use of ST products and ST assumes no liability for application assistance or the design of Purchasers' products.

No license, express or implied, to any intellectual property right is granted by ST herein.

Resale of ST products with provisions different from the information set forth herein shall void any warranty granted by ST for such product.

ST and the ST logo are trademarks of ST. All other product or service names are the property of their respective owners.

Information in this document supersedes and replaces information previously supplied in any prior versions of this document.

© 2017 STMicroelectronics - All rights reserved

